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Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	Z8
Core Size	8-Bit
Speed	12MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	14
Program Memory Size	2KB (2K x 8)
Program Memory Type	ОТР
EEPROM Size	-
RAM Size	125 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	18-SOIC (0.295", 7.50mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z86e0812ssg1866

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

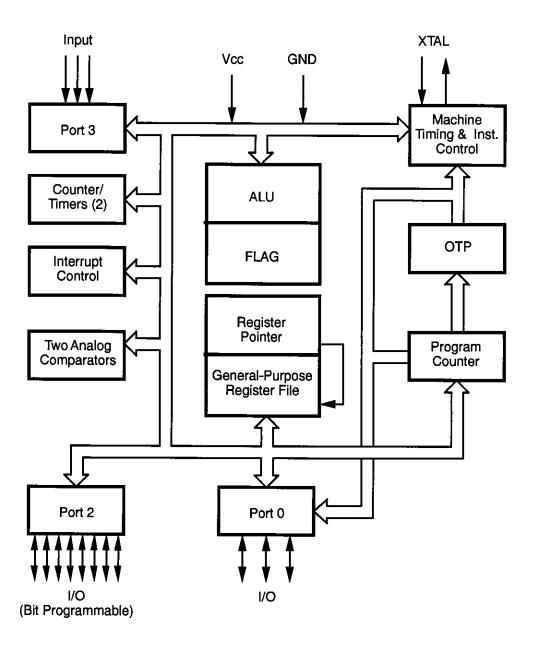


Figure 1. Functional Block Diagram

GENERAL DESCRIPTION (Continued)

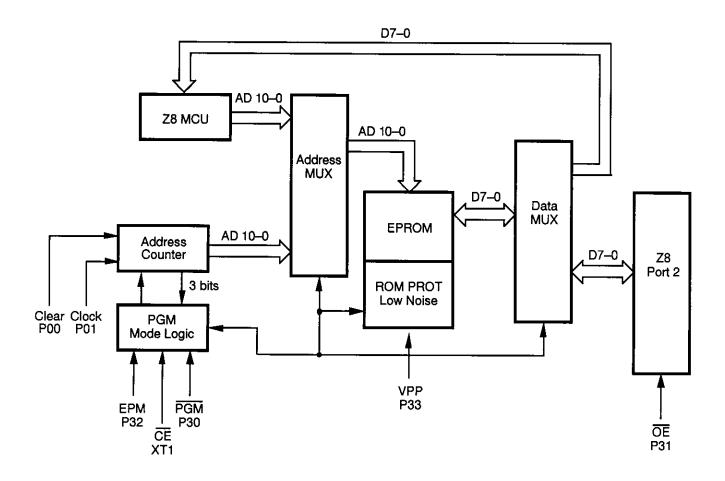


Figure 2. EPROM Programming Mode Block Diagram

PIN DESCRIPTION

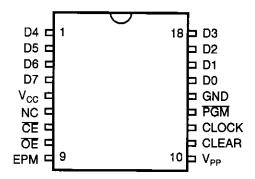


Figure 3. 18-Pin EPROM Mode Configuration

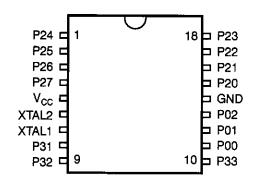


Figure 4. 18-Pin DIP/SOIC Mode Configuration

Table 1. 18-Pin DIP Pin Identification

EPROM	Programmi	ng Mode	
Pin#	Symbol	Function	Direction
1–4	D4-D7	Data 4, 5, 6, 7	In/Output
5	V _{cc}	Power Supply	
6	NC	No Connection	
7	CE	Chip Enable	Input
8	ŌĒ	Output Enable	Input
9	EPM	EPROM Prog Mode	Input
10	V _{PP}	Prog Voltage	Input
11	Clear	Clear Clock	Input
12	Clock	Address	Input
13	PGM	Prog Mode	Input
14	GND	Ground	
15–18	D0-D3	Data 0,1, 2, 3	In/Output

Table 2. 18-Pin DIP/SOIC Pin Identification

Standa	rd Mode		
Pin#	Symbol	Function	Direction
1–4	P24-P27	Port 2, Pins 4,5,6,7	In/Output
5	V _{CC}	Power Supply	<u></u>
6	XTAL2	Crystal Osc. Clock	Output
7	XTAL1	Crystal Osc. Clock	Input
8	P31	Port 3, Pin 1, AN1	Input
9	P32	Port 3, Pin 2, AN2	Input
10	P33	Port 3, Pin 3, REF	Input
11–13	P00-P02	Port 0, Pins 0,1,2	In/Output
14	GND	Ground	
15–18	P20-P23	Port 2, Pins 0,1,2,3	In/Output

STANDARD TEST CONDITIONS

The characteristics listed below apply for standard test conditions as noted. All voltages are referenced to Ground. Positive current flows into the referenced pin (Figure 5).

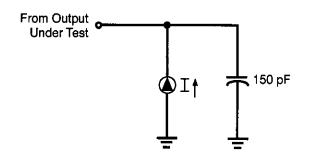


Figure 5. Test Load Diagram

CAPACITANCE

 $T_A = 25$ °C, $V_{CC} = GND = 0V$, f = 1.0 MHz, unmeasured pins returned to GND.

Parameter	Min	Max
Input capacitance	0	10 pF
Output capacitance	0	20 pF
I/O capacitance	0	25 pF

DC ELECTRICAL CHARACTERISTICS (Continued)

			• • • • • • • • • • • • • • • • • • • •	40°C to 5°C	Typical			
Sym	Parameter	V _{CC} [4]	Min	Max	@ 25°C	Units	Conditions	Notes
Icc	Supply Current	4.5V		11.0	6.8	mA	All Output and I/O Pins Floating @ 2 MHz	5,7
		5.5V		11.0	6.8	mA	All Output and I/O Pins Floating @ 2 MHz	5,7
		4.5V		15.0	8.2	mA	All Output and I/O Pins Floating @ 8 MHz	5,7
		5.5V		15.0	8.2	mA	All Output and I/O Pins Floating @ 8 MHz	5,7
		4.5V	_	20.0	12.0	mA	All Output and I/O Pins Floating @ 12 MHz	5,7
		5.5V		20.0	12.0	mA	All Output and I/O Pins Floating @ 12 MHz	5,7
I _{CC1}	Standby Current	4.5V		5.0	2.5	mA	HALT Mode V _{IN} = 0V, V _{CC} @ 2 MHz	5,7
		5.5V		5.0	2.5	mA	HALT Mode V _{IN} = 0V, V _{CC} @ 2 MHz	5,7
		4.5V	-10-	5.0	3.0	mA	HALT Mode V _{IN} = 0V, V _{CC} @ 8 MHz	5,7
		5.5V		5.0	3.0	mA	HALT Mode V _{IN} = 0V, V _{CC} @ 8 MHz	5,7
		4.5V	=	7.0	4.0	mA	HALT Mode V _{IN} = 0V, V _{CC} @ 12 MHz	5,7
		5.5V		7.0	4.0	mA	HALT Mode V _{IN} = 0V, V _{CC} @ 12 MHz	5,7
Icc	Supply Current (Low Noise Mode)	4.5V		11.0	6.8	mA	All Output and I/O Pins Floating @ 1 MHz	7
		5.5V		11.0	6.8	mA	All Output and I/O Pins Floating @ 1 MHz	7
		4.5V	,	13.0	7.5	mA	All Output and I/O Pins Floating @ 2 MHz	7
		5.5V		13.0	7.5	mA	All Output and I/O Pins Floating @ 2 MHz	7
		4.5V		15.0	8.2	mA	All Output and I/O Pins Floating @ 4 MHz	7
		5.5V		15.0	8.2	mA	All Output and I/O Pins Floating @ 4 MHz	7

AC ELECTRICAL CHARACTERISTICS

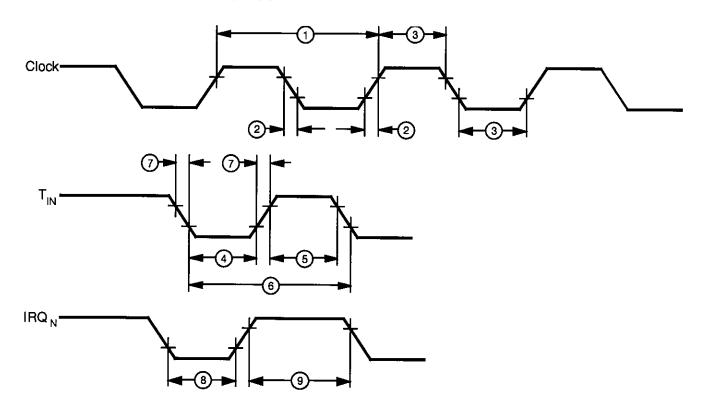


Figure 6. AC Electrical Timing Diagram

AC ELECTRICAL CHARACTERISTICS

Timing Table (Standard Mode for SCLK/TCLK = XTAL/2) Standard Temperature

15				7	T _A = 0 °C	to +70 °C	•	<u></u>	
				8 N	lHz	12	MHz		
No	Symbol	Parameter	V _{cc}	Min	Max	Min	Max	Units	Notes
1	TpC	Input Clock Period	4.5V	125	DC	83	DC	ns	1
			5.5V	125	DC	83	DC	ns	1
2	TrC,TfC	Clock Input Rise	4.5V	-8.	25		15	ns	1
		and Fall Times	5.5V		25		15	ns	1
3	TwC	Input Clock Width	4.5V	62		41		ns	1
			5.5V	62		41	,	ns	1
4	TwTinL	Timer Input Low Width	4.5V	100		100		ns	1
			5.5V	70	1	70		ns	1
5	TwTinH	Timer Input High Width	4.5V	5TpC		5TpC			1
			5.5V	5TpC		5TpC			1
6	TpTin	Timer Input Period	4.5V		8TpC	8TpC		•••	1
			5.5V		8TpC	8TpC			1
7	TrTin,	Timer Input Rise	4.5V		100		100	ns	1
	TtTin	and Fall Time	5.5V		100		100	ns	1
8	TwlL	Int. Request Input	4.5V	70		70		ns	1,2
		Low Time	5.5V	70		70		ns	1,2
9	TwiH	Int. Request Input	4.5V		5TpC	5TpC			1,2
		High Time	5.5V		5TpC	5TpC		-	1,2
10	Twdt	Watch-Dog Timer	4.5V	12	<u> </u>	12		ms	1
		Delay Time for Timeout	5.5V	12	·	12	· ·	ms	1
11	Tpor	Power-On Reset Time	4.5V	20	80	20	80	ms	1
			5.5V	20	80	20	80	ms	1

Notes:

^{1.} Timing Reference uses 0.7 $\rm V_{CC}$ for a logic 1 and 0.2 $\rm V_{CC}$ for a logic 0.

^{2.} Interrupt request through Port 3 (P33-P31).

AC ELECTRICAL CHARACTERISTICS

Low Noise Mode, Standard Temperature

				Т	_= 0 °C t	o +70 °C			
				1 M		4 M	Hz		
No	Symbol	Parameter	v_{cc}	Min	Max	Min	Max	Units	Notes
1	TPC	Input Clock Period	4.5V	1000	DC	250	DC	ns	1
		-	5.5V	1000	DC	250	DC	ns	1
2	TrC	Clock Input Rise	4.5V		25		25	ns	1
	TfC	and Fall Times	5.5V		25	,	25	ns	1
3	TwC	Input Clock Width	4.5V	500		125		ns	1
		-	5.5V	500		125		ns	1
4.	TwTinL	Timer Input Low Width	4.5V	70	•	70		ns	1
		-	5.5V	70		70		ns	1
5	TwTinH	Timer Input High Width	4.5V	2.5TpC		2.5TpC			1
		-	5.5V	2.5TpC		2.5TpC		.,	1
6	TpTin	Timer Input Period	4.5V	4TpC		4TpC			1
		-	5.5V	4TpC		4TpC			1
7	TrTin,	Timer Input Rise	4.5V	· ·	100		100	ns	1
	TtTin	and Fall Time	5.5V		100		100	ns	1
8	TwiL	Int. Request Input	4.5V	70		70	_	ns	1,2
	Low Time	•	5.5V	70		70		ns	1,2
9	TwiH	Int. Request Input	4.5V	2.5TpC		2.5TpC			1,2
	High Time	•	5.5V	2.5TpC		2.5TpC			1,2
10	Twdt	Watch-Dog Timer	4.5V	12		12		ms	1
		Delay Time for Timeout	5.5V	12		12		ms	1

Notes:

- Timing Reference uses 0.7 V_{CC} for a logic 1 and 0.2 V_{CC} for a logic 0.
 Interrupt request through Port 3 (P33–P31).

AC ELECTRICAL CHARACTERISTICS (Continued)

Low Noise Mode, Extended Temperature

				T,	= -40 °C	to +105 °	C		
				1 M		4 M			
No	Symbol	Parameter	V _{cc}	Min	Max	Min	Max	Units	Notes
1	TPC	Input Clock Period	4.5V	1000	DC	250	DC	ns	1
			5.5V	1000	DC	250	DC	ns	1
2	TrC	Clock Input Rise	4.5V		25		25	ns	1
	TfC	and Fall Times	5.5V		25	-	25	ns	1
3	TwC	Input Clock Width	4.5V	500		125		ns	1
			5.5V	500		125		ns	1
4.	TwTinL	Timer Input Low Width	4.5V	70		70		ns	1
			5.5V	70		70		ns	1
5	TwTinH	Timer Input High Width	4.5V	2.5TpC		2.5TpC	 -		1
			5.5V	2.5TpC	•	2.5TpC			1
6	TpTin	Timer Input Period	4.5V		4TpC	4TpC			1
			5.5V		4TpC	4TpC			1
7	TrTin,	Timer Input Rise	4.5V		100	•	100	ns	1
	TtTin	and Fall Time	5.5V		100		100	ns	1
8	TwlL	Int. Request Input	4.5V	70		70		ns	1,2
		Low Time	5.5V	70		70		ns	1,2
9	TWIH	Int. Request Input	4.5V	2.5TpC		2.5TpC			1,2
		High Time	5.5V	2.5TpC		2.5TpC			1,2
10	Twdt	Watch-Dog Timer	4.5V	10		10		ms	1
		Delay Time for Timeout	5.5V	10		10		ms	1

Notes:

^{1.} Timing Reference uses 0.7 $\rm V_{CC}$ for a logic 1 and 0.2 $\rm V_{CC}$ for a logic 0.

^{2.} Interrupt request through Port 3 (P33-P31).

PIN FUNCTIONS (Continued)

XTAL1, XTAL2 Crystal In, Crystal Out (time-based input and output, respectively). These pins connect a parallel-resonant crystal, LC, or an external single-phase clock (8 MHz or 12 MHz max) to the on-chip clock oscillator and buffer.

Port 0, P02—P00. Port 0 is a 3-bit bidirectional, Schmitt-triggered CMOS-compatible I/O port. These three I/O lines can be globally configured under software control to be inputs or outputs (Figure 7).

Auto Latch. The Auto Latch puts valid CMOS levels on all CMOS inputs (except P33, P32, P31) that are not externally driven. A valid CMOS level, rather than a floating node, reduces excessive supply current flow in the input buffer. On Power-up and Reset, the Auto Latch will set the ports to an undetermined state of 0 or 1. Default condition is Auto Latches enabled.

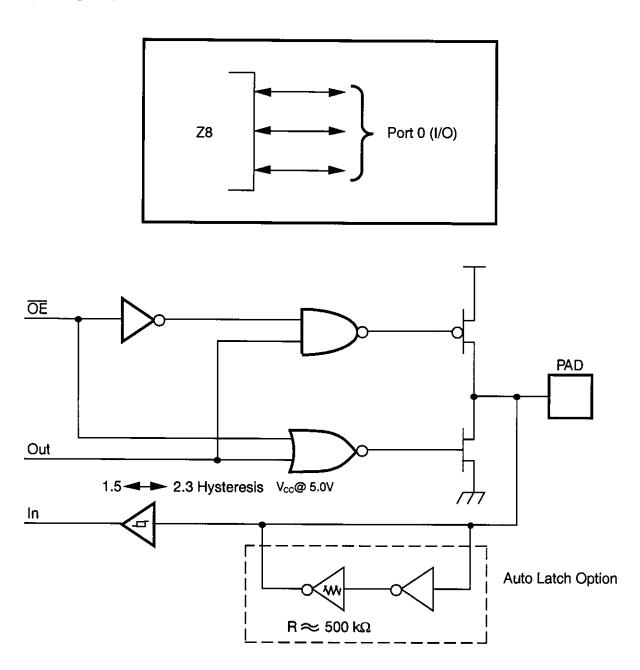


Figure 7. Port 0 Configuration

Port 2, P27-P20. Port 2 is an 8-bit, bit programmable, bidirectional, Schmitt-triggered CMOS-compatible I/O port. These eight I/O lines can be configured under software

control to be inputs or outputs, independently. Bits programmed as outputs can be globally programmed as either push-pull or open-drain (Figure 8).

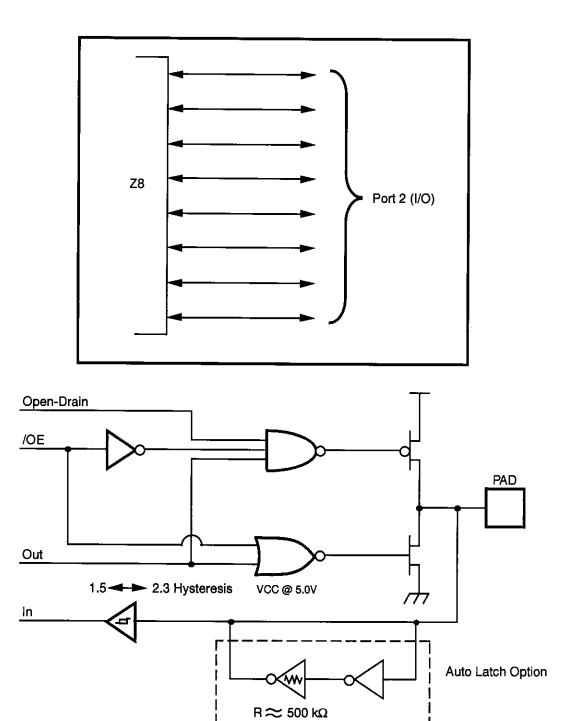
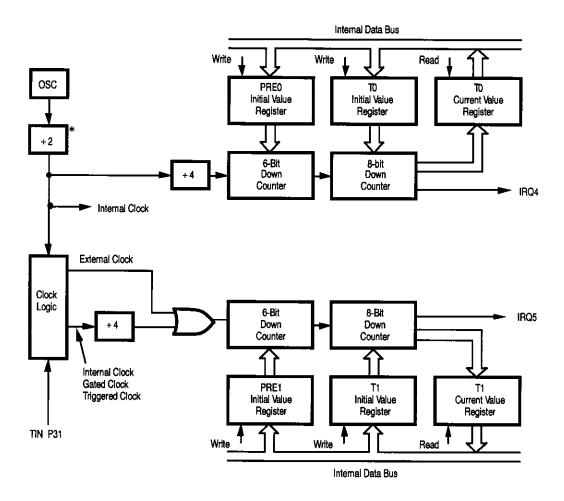


Figure 8. Port 2 Configuration

Table 3. Control Registers

Reset Condition										***************************************
Addr.	Reg.	D7	D6	D5	D4	D3	D2	D1	D0	Comments
FF	SPL	0	0	0	0	0	0	0	0	-
FD	RP	0	0	0	0	0	0	0	0	
FC	FLAGS	U	Ū	U	U	Ü	U	U	U	
FB	IMR	0	U	U	U	U	U	U	U	
FA	IRQ	U	U	0	0	0	0	0	0	IRQ3 is used for positive edge detection
F9	IPR	U	Ų	Ū	U	U	U	U	U	
F8*	P01M	U	U	U	0	U	U	0	1	
F7*	P3M	U	U	U	Ū	U	Ü	0	0	
F6*	P2M	1	1	1	1	1	1	1	1	Inputs after reset
F5	PRE0	U	U	Ū	U	U	U	Ū	0	
F4	TO	U	U	U	U	U	U	U	U	
F3	PRE1	U	Ū	U	Ū	U	Ü	0	0	
F2	T1	U	U	U	Ū	U	Ü	U	U	
F1	TMR	0	0	0	0	0	0	0	0	

Note: *Registers are not reset after a STOP-Mode Recovery using P27 pin. A subsequent reset will cause these control registers to be reconfigured as shown in Table 4 and the user must avoid bus contention on the port pins or it may affect device reliability.



^{*} Note: By passed, if Low EMI Mode is selected.

Figure 14. Counter/Timers Block Diagram

Interrupts. The Z8 has six interrupts from six different sources. These interrupts are maskable and prioritized (Figure 15). The sources are divided as follows: the falling edge of P31 (AN1), P32 (AN2), P33 (REF), the rising edge of P32 (AN2), and two counter/timers. The Interrupt Mask Register globally or individually enables or disables the six interrupt requests (Table 4).

When more than one interrupt is pending, priorities are resolved by a programmable priority encoder that is controlled by the Interrupt Priority register. All Z8 interrupts are vectored through locations in program memory. When an Interrupt machine cycle is activated, an Interrupt Request is granted. This disables all subsequent interrupts, saves the Program Counter and Status Flags, and then branches to the program memory vector location reserved for that interrupt. This memory location and the next byte contain the 16-bit starting address of the interrupt service routine for that particular interrupt request.

To accommodate polled interrupt systems, interrupt inputs are masked and the interrupt request register is polled to determine which of the interrupt requests needs service.

Note: User must select any Z86E08 mode in Zilog's C12 ICEBOX[™] emulator. The rising edge interrupt is not supported on the CCP emulator (a hardware/software workaround must be employed).

Table 4. Interrupt Types, Sources, and Vectors

Name	Source	Vector Location	Comments
IRQ0	AN2(P32)	0,1	External (F)Edge
IRQ1	REF(P33)	2,3	External (F)Edge
IRQ2	AN1(P31)	4,5	External (F)Edge
IRQ3	AN2(P32)	6,7	External (R)Edge
IRQ4	TO	8,9	Internal
IRQ5	T1	10,11	Internal

Notes:

F = Falling edge triggered

R = Rising edge triggered

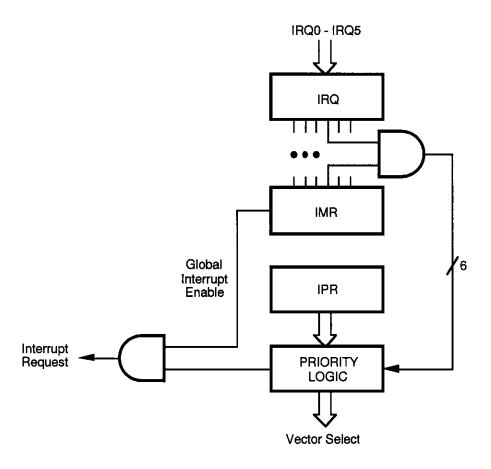
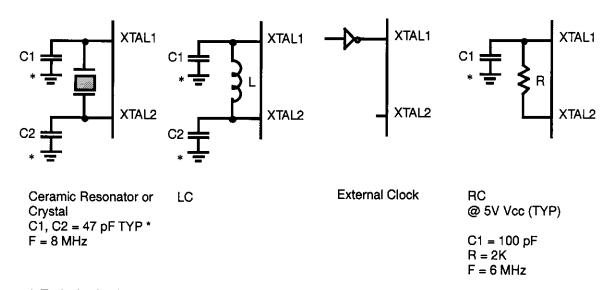


Figure 15. Interrupt Block Dlagram

Clock. The Z8 on-chip oscillator has a high-gain, parallel-resonant amplifier for connection to a crystal, LC, RC, ceramic resonator, or any suitable external clock source (XTAL1 = INPUT, XTAL2 = OUTPUT). The crystal should be AT cut, up to 12 MHz max., with a series resistance (RS) of less than or equal to 100 Ohms.

The crystal should be connected across XTAL1 and XTAL2 using the vendors crystal recommended capacitors from each pin directly to device ground pin 14 (Figure 16). Note that the crystal capacitor loads should be connected to $V_{\rm SS}$, Pin 14 to reduce Ground noise injection.



^{*} Typical value including pin parasitics

Figure 16. Oscillator Configuration

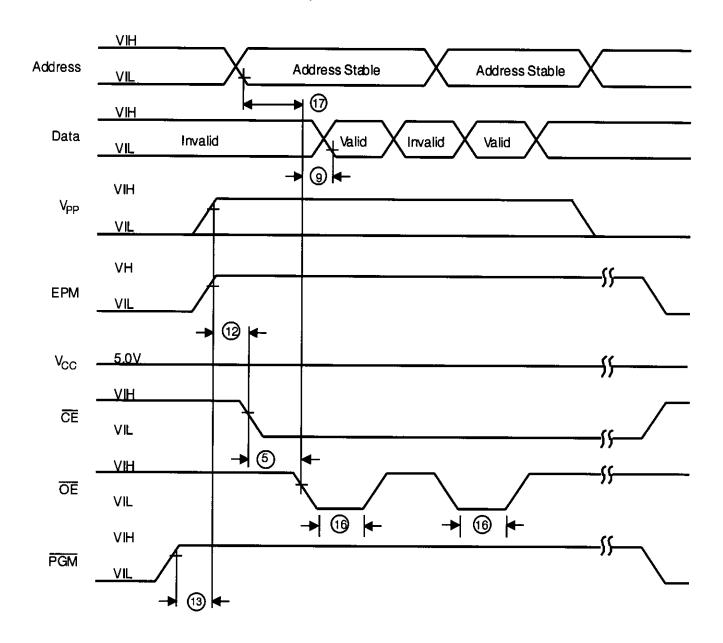


Figure 19. Z86E04/E08 Programming Waveform (EPROM Read)

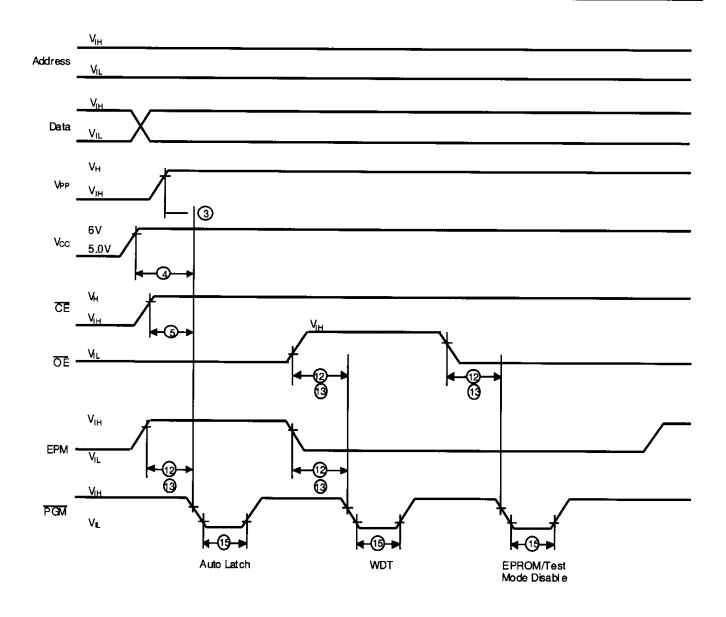


Figure 22. Z86E04/E08 Programming Options Waveform (Auto Latch Disable, Permanent WDT Enable and EPROM/Test Mode Disable)

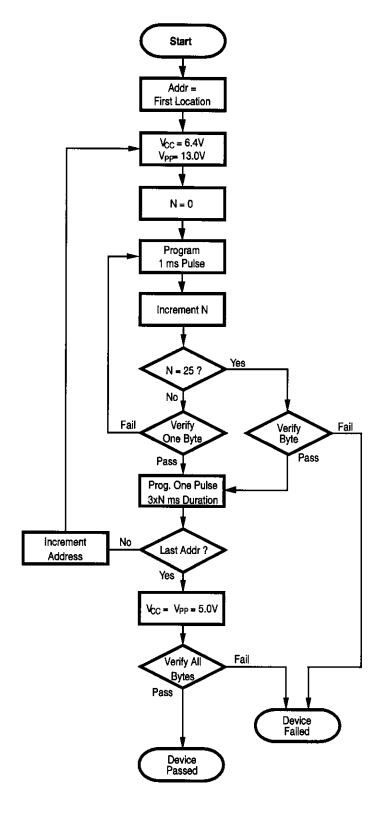
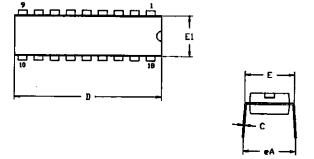
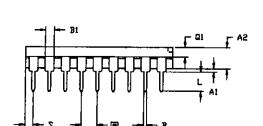


Figure 23. Z86E04/E08 Programming Algorithm

PACKAGE INFORMATION

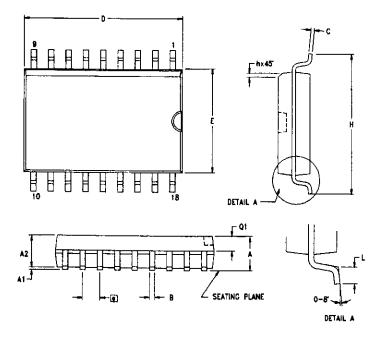




LDEMYZ	MILLI	METER	INC	CH
	MIN	MAX	MIN	MAX
A1	0.51	0.81	.020	.032
SA	3.25	3.43	.128	.135
В	0.38	0.53	.015	.021
Bl	1.14	1.65	.045	.065
С	0.23	0.38	.009	.015
D	22.35	23.37	.880	.920
E	7.62	8.13	.300	.320
El	6.22	6.48	.245	.255
	2,54	TYP	.100	TYP
eA	7.87	8.89	.310	.350
<u> </u>	3.18	3.81	.125	.150
Ωį	1.52	1.65	.060	.065
2	0.89	1.65	.035	.065

CONTROLLING DIMENSIONS : INCH

18-Pin DIP Package Diagram



SYMBOL	MILLI	METER	INCH			
21 MBDL	MIN	MAX	KIN	MAX		
A	2.40	2.65	0.094	0.104		
A1	0.10	0.30	0.004	0.012		
A2	2.24	2.44	0.088	0.096		
8	0.36	0.46	0.014	0.018		
С	0.23	0.30	0.009	0.012		
D	11.40	11.75	0.449	0.463		
E	7.40	7.60	0.291	0.299		
(1.27	TYP	0.05	O TYP		
Н	10.00	10.65	0.394	0.419		
h	0.30	0.50	0.012	0.020		
_ L	0.60	1.00	0.024	0.039		
Q1	0.97	1.07	0.038	0.042		

CONTROLLING DIMENSIONS : MM LEADS ARE COPLANAR WITHIN .004 INCH.

18-Pin SOIC Package Diagram

Pre-Characterization Product:

The product represented by this CPS is newly introduced and Zilog has not completed the full characterization of the product. The CPS states what Zilog knows about this product at this time, but additional features or nonconformance with some aspects of the CPS may be

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